

ST333C..C SERIES

INVERTER GRADE THYRISTORS

Hockey Puk Version

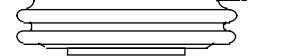
Features

- Metal case with ceramic insulator
- International standard case TO-200AB (E-PUK)
- All diffused design
- Center amplifying gate
- Guaranteed high dV/dt
- Guaranteed high di/dt
- High surge current capability
- Low thermal impedance
- High speed performance

720A

Typical Applications

- Inverters
- Choppers
- Induction heating
- All types of force-commutated converters



case style TO-200AB (E-PUK)

Major Ratings and Characteristics

Parameters	ST333C..C	Units
$I_{T(AV)}$ @ T_{hs}	720	A
	55	°C
$I_{T(RMS)}$ @ T_{hs}	1435	A
	25	°C
I_{TSM} @ 50Hz	11000	A
	11500	A
I^2t @ 50Hz	605	KA ² s
	553	KA ² s
V_{DRM}/V_{RRM}	400 to 800	V
t_q range	10 to 30	μs
T_J	- 40 to 125	°C

ST333C..C Series

Bulletin I25170 rev. A 05/94

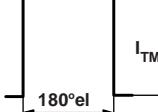
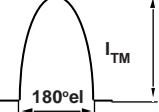
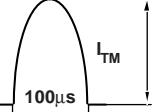
International
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ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{DRM}/V_{RRM} , maximum repetitive peak voltage V	V_{RSM} , maximum non-repetitive peak voltage V	I_{DRM}/I_{RRM} max. @ $T_J = T_{J\max}$. mA
ST333C..C	04	400	500	50
	08	800	900	

Current Carrying Capability

Frequency					Units
50Hz	1630	1420	2520	2260	A
400Hz	1630	1390	2670	2330	
1000Hz	1350	1090	2440	2120	
2500Hz	720	550	1450	1220	
Recovery voltage V_r	50	50	50	50	V
Voltage before turn-on V_d	V_{DRM}	V_{DRM}	V_{DRM}	V_{DRM}	
Rise of on-state current dI/dt	50	50	-	-	A/ μ s
Heatsink temperature	40	55	40	55	°C
Equivalent values for RC circuit	10Ω / 0.47μF	10Ω / 0.47μF	10Ω / 0.47μF	10Ω / 0.47μF	

On-state Conduction

Parameter	ST333C..C	Units	Conditions			
$I_{T(AV)}$ Max. average on-state current @ Heatsink temperature	720 (350)	A	180° conduction, half sine wave			
	55 (75)	°C	double side (single side) cooled			
$I_{T(RMS)}$ Max. RMS on-state current	1435		DC @ 25°C heatsink temperature double side cooled			
I_{TSM} Max. peak, one half cycle, non-repetitive surge current	11000	A	t = 10ms	No voltage	Sinusoidal half wave, Initial $T_J = T_{J\max}$	
	11500		t = 8.3ms	reapplied		
	9250		t = 10ms	100% V_{RRM}		
	9700		t = 8.3ms	reapplied		
I^2t Maximum I^2t for fusing	605	KA ² s	t = 10ms	No voltage	Initial $T_J = T_{J\max}$	
	553		t = 8.3ms	reapplied		
	428		t = 10ms	100% V_{RRM}		
	391		t = 8.3ms	reapplied		
$I^{2\sqrt{t}}$ Maximum $I^{2\sqrt{t}}$ for fusing	6050	KA ² /s	t = 0.1 to 10ms, no voltage reapplied			

On-state Conduction

Parameter	ST333C..C	Units	Conditions	
V_{TM}	Max. peak on-state voltage	1.96	V	$I_{TM} = 1810A, T_J = T_J \text{ max}, t_p = 10\text{ms sine wave pulse}$
$V_{T(TO)1}$	Low level value of threshold voltage	0.91		$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$
$V_{T(TO)2}$	High level value of threshold voltage	0.93		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
r_{t1}	Low level value of forward slope resistance	0.58	$\text{m}\Omega$	$(16.7\% \times \pi \times I_{T(AV)} < I < \pi \times I_{T(AV)}, T_J = T_J \text{ max.})$
r_{t2}	High level value of forward slope resistance	0.58		$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ max.}$
I_H	Maximum holding current	600	mA	$T_J = 25^\circ\text{C}, I_T > 30\text{A}$
I_L	Typical latching current	1000		$T_J = 25^\circ\text{C}, V_A = 12\text{V}, R_a = 6\Omega, I_G = 1\text{A}$

Switching

Parameter	ST333C..C	Units	Conditions
di/dt	Max. non-repetitive rate of rise of turned-on current	$\text{A}/\mu\text{s}$	$T_J = T_J \text{ max}, V_{DRM} = \text{rated } V_{DRM}$
			$I_{TM} = 2 \times di/dt$
t_d	Typical delay time	μs	$T_J = 25^\circ\text{C}, V_{DM} = \text{rated } V_{DRM}, I_{TM} = 50\text{A DC}, t_p = 1\mu\text{s}$
t_q	Max. turn-off time		Resistive load, Gate pulse: 10V, 5Ω source
	Min 10 Max 30		$T_J = T_J \text{ max}, I_{TM} = 550\text{A}, \text{commutating } di/dt = 40\text{A}/\mu\text{s}$
			$V_R = 50\text{V}, t_p = 500\mu\text{s}, dv/dt: \text{see table in device code}$

Blocking

Parameter	ST333C..C	Units	Conditions
dv/dt	Maximum critical rate of rise of off-state voltage	$\text{V}/\mu\text{s}$	$T_J = T_J \text{ max, linear to } 80\% V_{DRM}$, higher value available on request
I_{RRM}	Max. peak reverse and off-state leakage current	mA	$T_J = T_J \text{ max, rated } V_{DRM}/V_{RRM} \text{ applied}$

Triggering

Parameter	ST333C..C	Units	Conditions
P_{GM}	Maximum peak gate power	W	$T_J = T_J \text{ max., } f = 50\text{Hz, d\% = 50}$
$P_{G(AV)}$	Maximum average gate power		
I_{GM}	Max. peak positive gate current	A	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
$+V_{GM}$	Maximum peak positive gate voltage		
$-V_{GM}$	Maximum peak negative gate voltage	V	$T_J = T_J \text{ max, } t_p \leq 5\text{ms}$
I_{GT}	Max. DC gate current required to trigger	mA	$T_J = 25^\circ\text{C}, V_A = 12\text{V}, R_a = 6\Omega$
V_{GT}	Max. DC gate voltage required to trigger		
I_{GD}	Max. DC gate current not to trigger	mA	$T_J = T_J \text{ max, rated } V_{DRM} \text{ applied}$
V_{GD}	Max. DC gate voltage not to trigger		

ST333C..C Series

Bulletin I25170 rev. A 05/94

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Thermal and Mechanical Specification

Parameter	ST333C..C	Units	Conditions
T_J	Max. operating temperature range	-40 to 125	°C
T_{sg}	Max. storage temperature range	-40 to 150	
R_{thJ-hs}	Max. thermal resistance, junction to heatsink	0.09 0.04	K/W
R_{thC-hs}	Max. thermal resistance, case to heatsink	0.020 0.010	
F	Mounting force, $\pm 10\%$	9800 (1000)	N (Kg)
wt	Approximate weight	83	g
Case style	TO - 200AB (E-PUK)	See Outline Table	

ΔR_{thJ-hs} Conduction

(The following table shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC)

Conduction angle	Sinusoidal conduction		Rectangular conduction		Units	Conditions
	Single Side	Double Side	Single Side	Double Side		
180°	0.010	0.011	0.007	0.007	K/W	$T_J = T_{J \text{ max.}}$
120°	0.012	0.012	0.012	0.013		
90°	0.015	0.015	0.016	0.017		
60°	0.022	0.022	0.023	0.023		
30°	0.036	0.036	0.036	0.036		

Ordering Information Table

Device Code	ST	33	3	C	08	C	H	K	1	1	2	3	4	5	6	7	8	9	10
1	- Thyristor																		
2	- Essential part number																		
3	- 3 = Fast turn off																		
4	- C = Ceramic Puk																		
5	- Voltage code: Code x 100 = V_{RRM} (See Voltage Rating Table)																		
6	- C = Puk Case TO-200AB (E-PUK)																		
7	- Reapplied dv/dt code (for t_q test condition)																		
8	- t_q code _____																		
9	- 0 = Eyelet term. (Gate and Aux. Cathode Unsoldered Leads)																		
	1 = Fast-on term. (Gate and Aux. Cathode Unsoldered Leads)																		
	2 = Eyelet term. (Gate and Aux. Cathode Soldered Leads)																		
	3 = Fast-on term. (Gate and Aux. Cathode Soldered Leads)																		
10	- Critical dv/dt:																		
	None = 500V/ μ sec (Standard value)																		
	L = 1000V/ μ sec (Special selection)																		

dv/dt - t_q combinations available

dv/dt (V/ μ s)	20	50	100	200	400
10	CN	DN	EN	--	--
12	CM	DM	EM	FM *	--
15	CL	DL	EL	FL *	HL
18	CP	DP	EP	FP	HP
20	CK	DK	EK	FK	HK
25	--	--	--	FJ	HJ
30	--	--	--	--	HH

*Standard part number.
All other types available only on request.

Outline Table

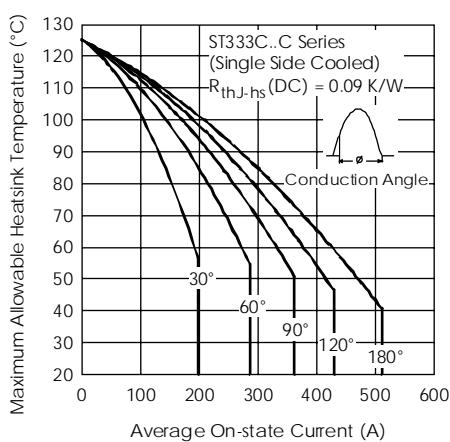
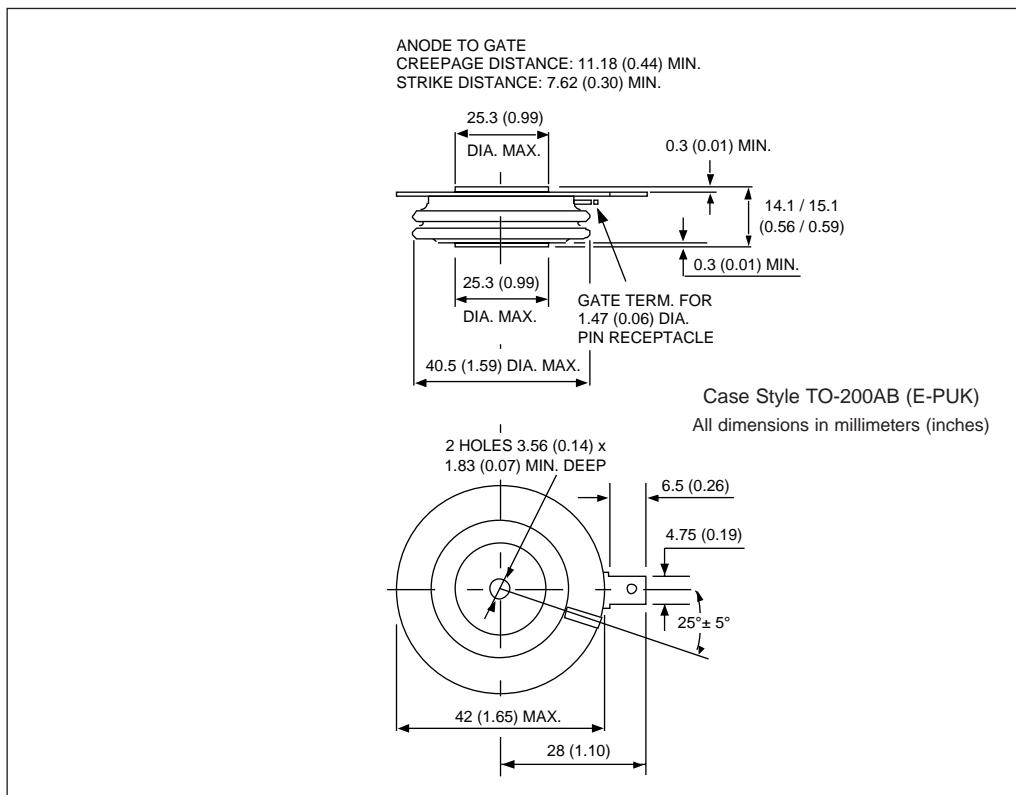


Fig. 1 - Current Ratings Characteristics

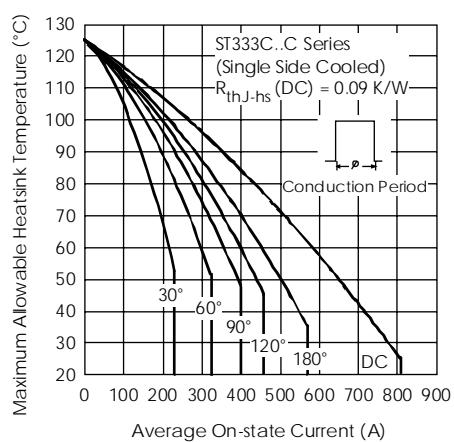


Fig. 2 - Current Ratings Characteristics

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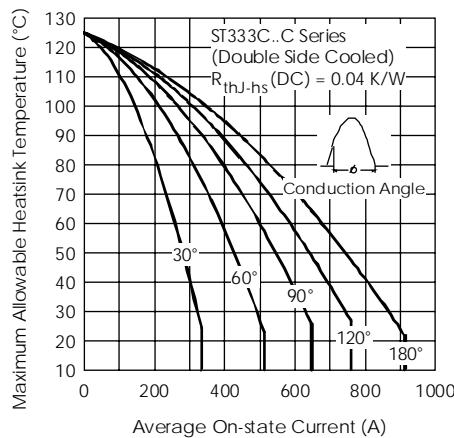


Fig. 3 - Current Ratings Characteristics

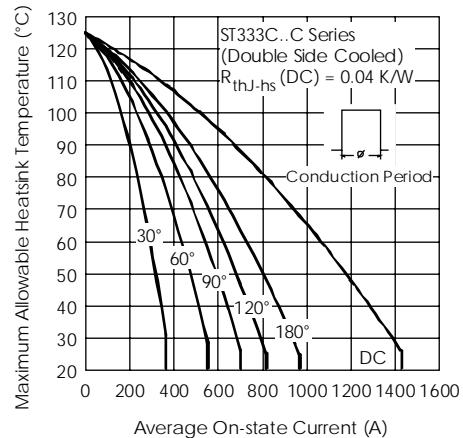


Fig. 4 - Current Ratings Characteristics

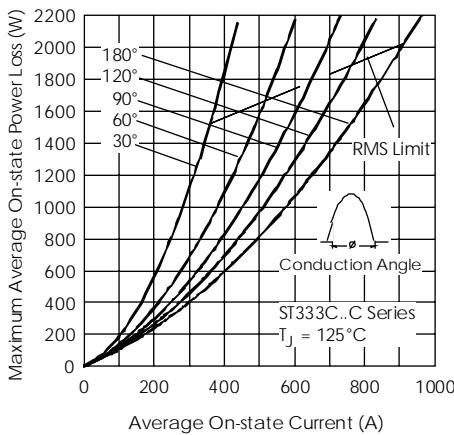


Fig. 5 - On-state Power Loss Characteristics

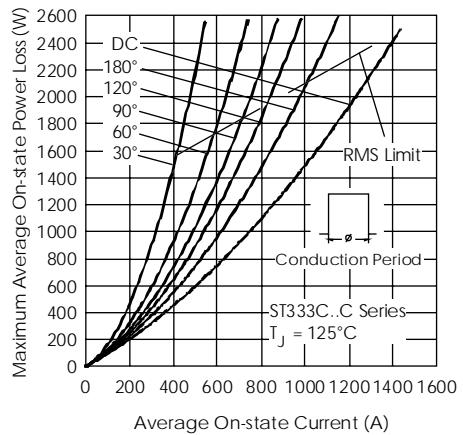


Fig. 6 - On-state Power Loss Characteristics

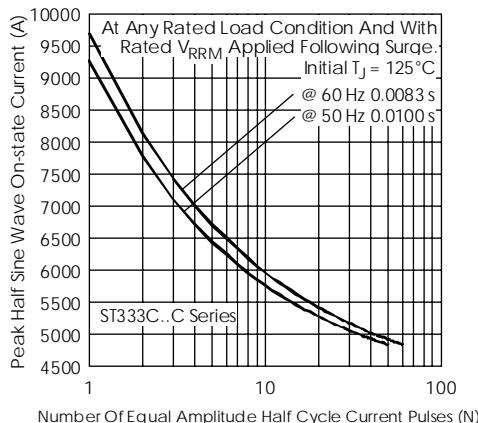


Fig. 7 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

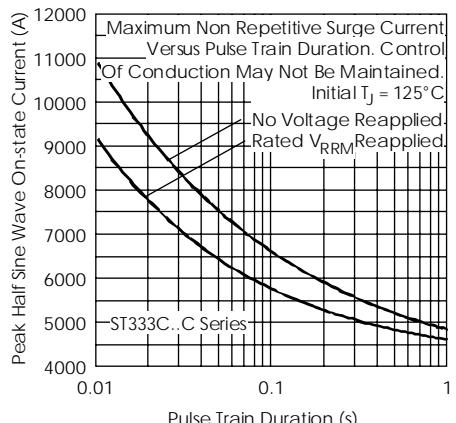


Fig. 8 - Maximum Non-repetitive Surge Current
Single and Double Side Cooled

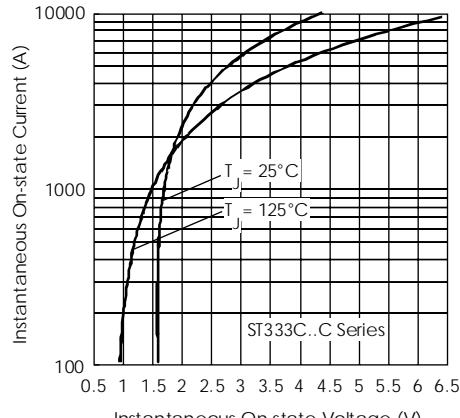


Fig. 9 - On-state Voltage Drop Characteristics

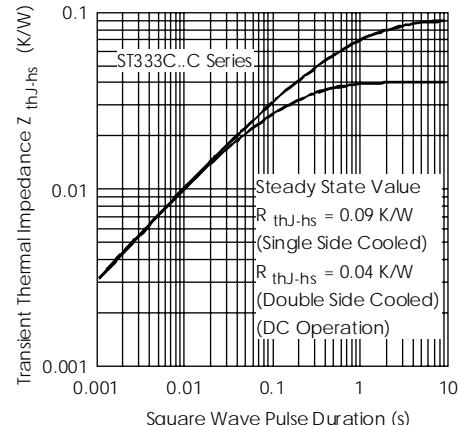


Fig. 10 - Thermal Impedance Z_{thJ-hs} Characteristics

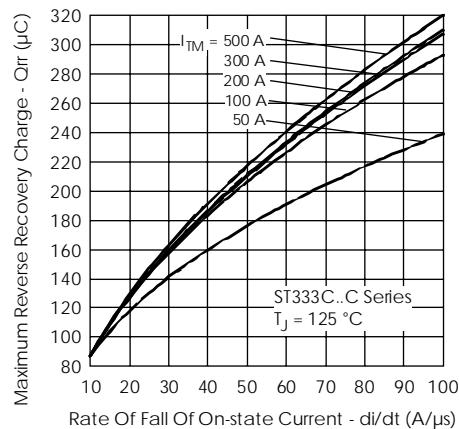


Fig. 11 - Reverse Recovered Charge Characteristics

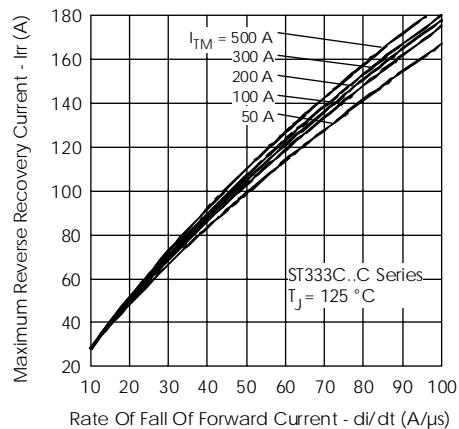


Fig. 12 - Reverse Recovery Current Characteristics

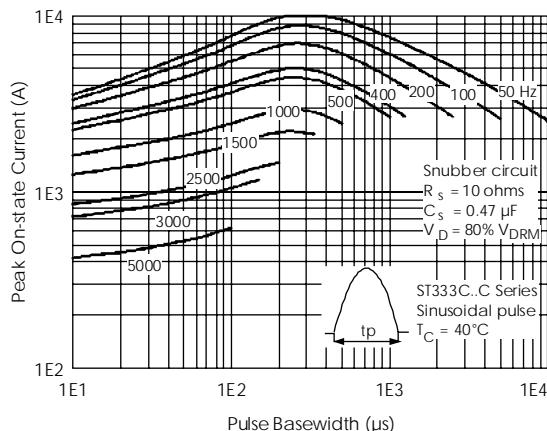
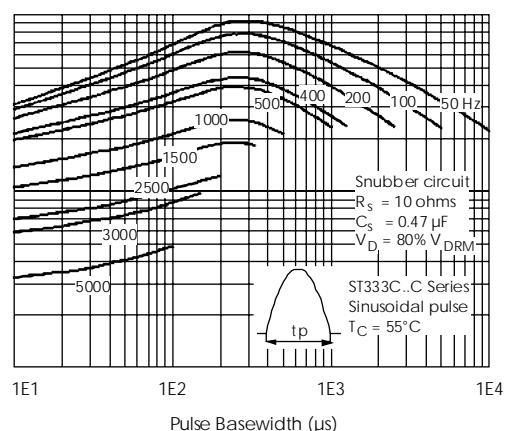


Fig. 13 - Frequency Characteristics



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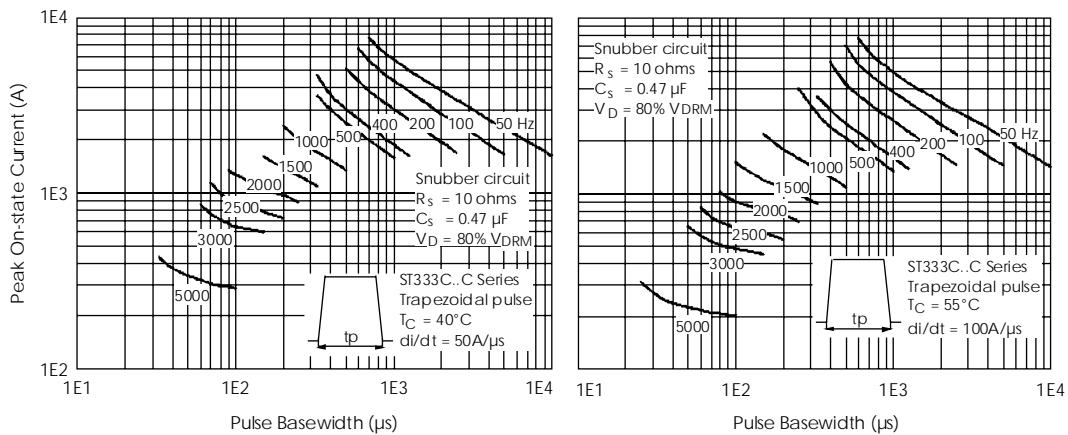


Fig. 14 - Frequency Characteristics

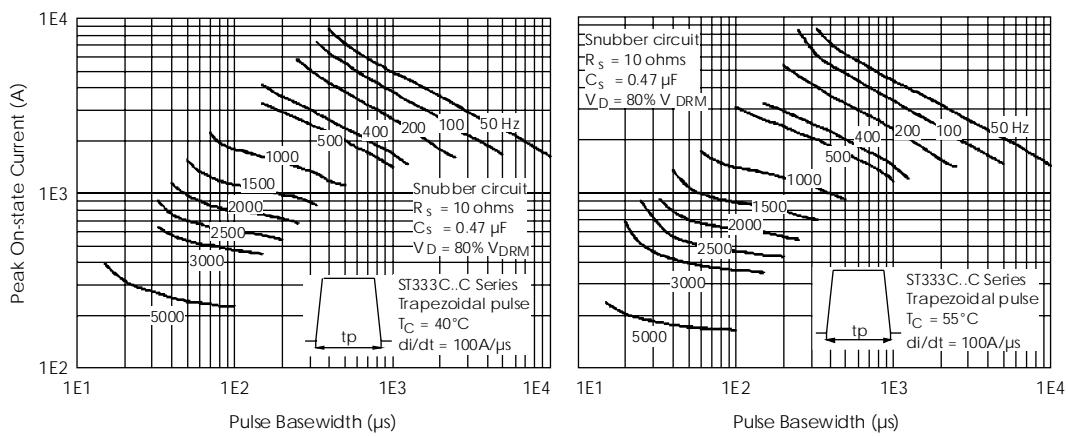


Fig. 15 - Frequency Characteristics

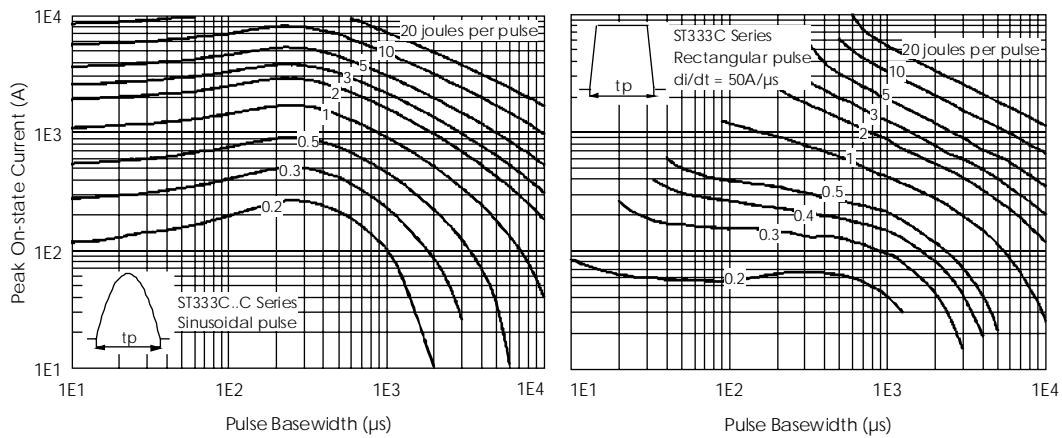


Fig. 16 - Maximum On-state Energy Power Loss Characteristics

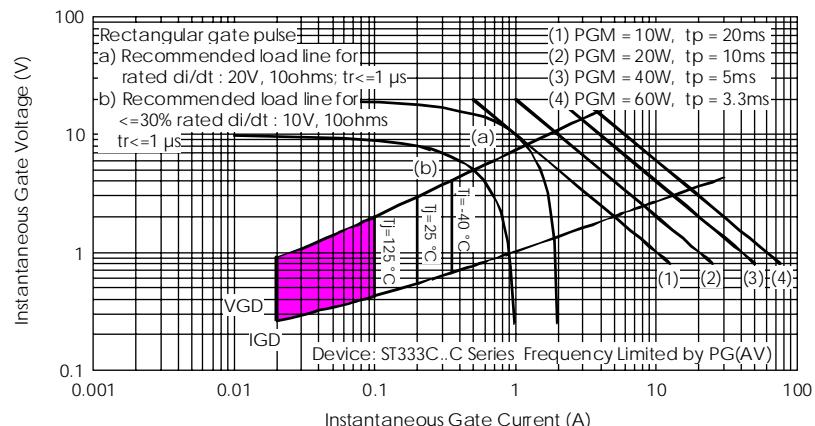


Fig. 17 - Gate Characteristics